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Electropolishing 1300 & 400 MHz SRF copper

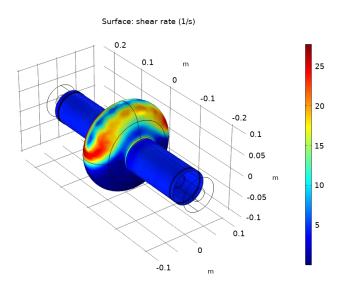
Gloria Bellini, Leonel Ferreira, Pierre Hugon FCC Week 2022

31st of May 2022

Contents

- Electropolishing modelling and optimisation
- Experimental achievements

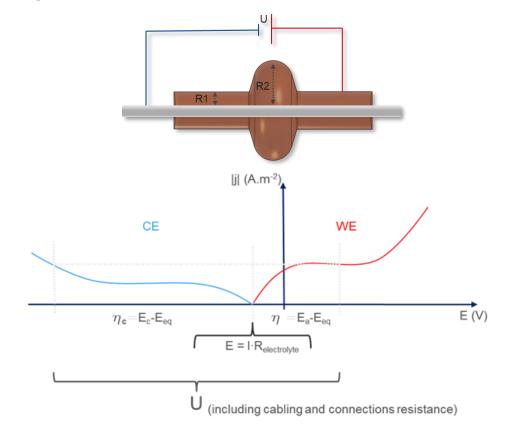




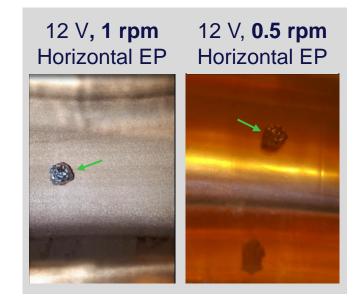
working parameters

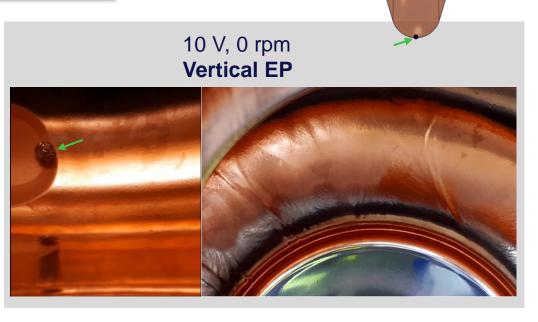
$$i = f(U, T, v_b, S_c/S_a, \sigma_l, [b])$$

- i, Current density
- U, Overall applied tension
- T_b, Bath temperature
- v_b, Bath fluid dynamics
- Sc/Sa, Cathode geometry & Cathodic/Anodic surface ratio
- σ_{l} , Bath conductivity
- [b], Bath composition



Evidence of fluid dynamics impact on EP



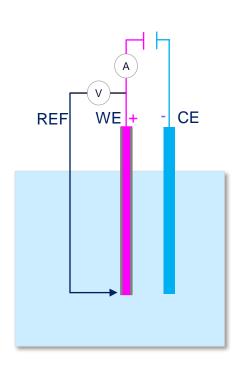


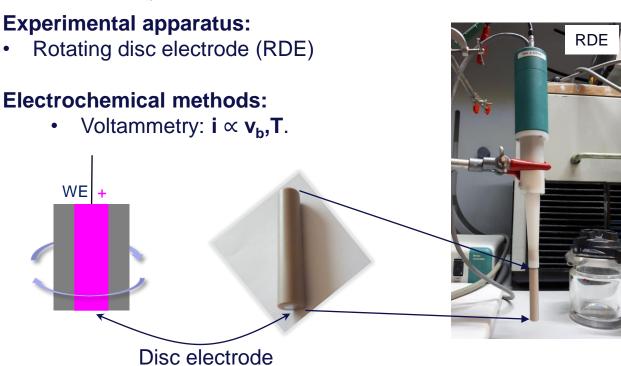
1.3 GHz (N2) cavity on different runs with different working parameters

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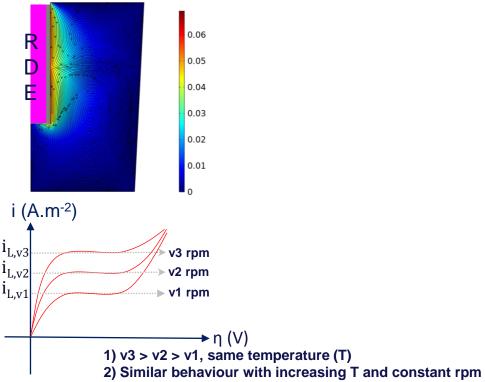
Electropolishing modelling and optimisation

How to assess fluid dynamics (v_b) and temperature (T) impact on EP?

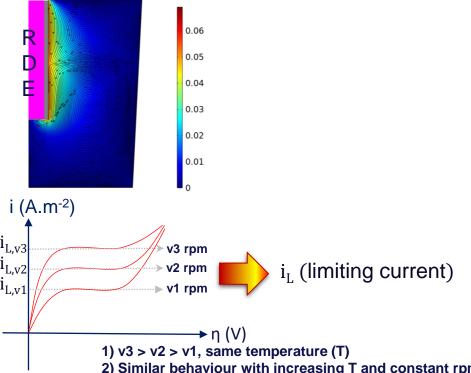




Bath velocity magnitude (m/s)

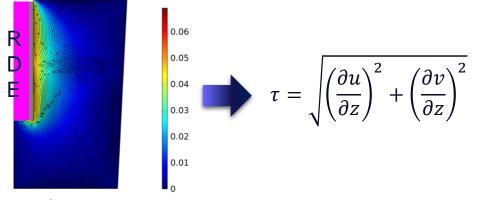


Bath velocity magnitude (m/s)

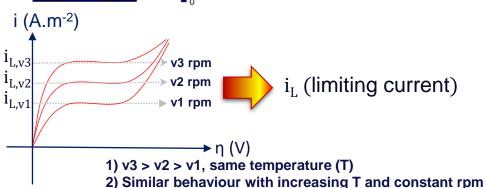


2) Similar behaviour with increasing T and constant rpm

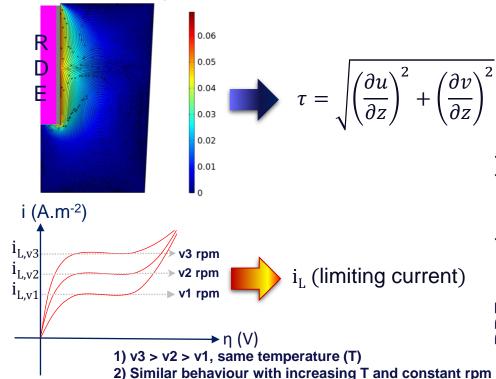
Bath velocity magnitude (m/s)



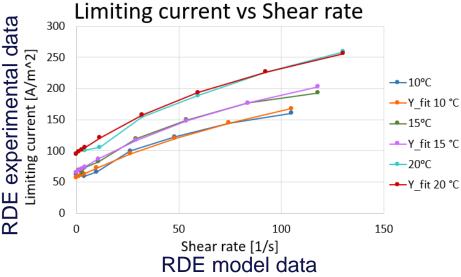
Shear rate (τ) is the rate of change in velocity at which one layer of fluid passes over an adjacent layer



Bath velocity magnitude (m/s)

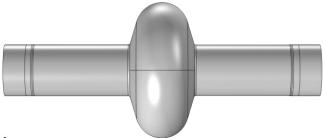


Shear rate (τ) is the rate of change in velocity at which one layer of fluid passes over an adjacent layer





Application of: $i = f(\eta)$



1.3GHz

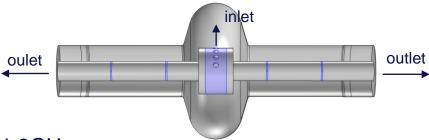
Mass flow rate: 30 L/min

Temperature: 15 °C

0.5 rotations per minute

Overall applied tension: 7.4 V

Application of: $i = f(\eta)$



1.3GHz

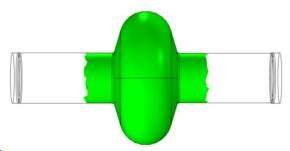
Mass flow rate: 30 L/min

Temperature: 15 °C

0.5 rotations per minute

Overall applied tension: 7.4 V

Application of: $i = f(\eta)$



1.3GHz

Mass flow rate: 30 L/min

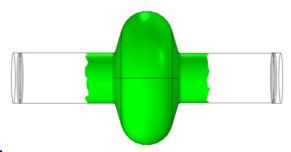
Temperature: 15 °C

0.5 rotations per minute

Overall applied tension: 7.4 V

Electropolished area

Application of: $i = f(\eta)$



1.3GHz

Mass flow rate: 30 L/min

Temperature: 15 °C

0.5 rotations per minute

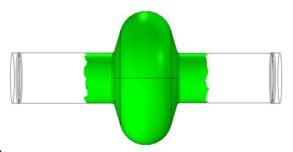
Overall applied tension: 7.4 V

Creation of a new anodic current density function, originated from the results obtained with the RDE:

Electropolishing 1300 & 400 MHz SRF copper, 31/05/2022

$$i = f(\eta, \tau)$$

Application of: $i = f(\eta)$



1.3GHz

Mass flow rate: 30 L/min

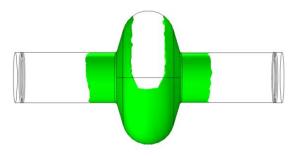
Temperature: 15 °C

0.5 rotations per minute

Overall applied tension: 7.4 V

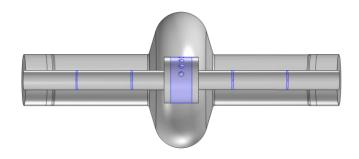
Creation of a new anodic current density function, originated from the results obtained with the RDE:

$$i=f(\eta,\tau)$$



Electropolished area

Original 1.3GHz cavity



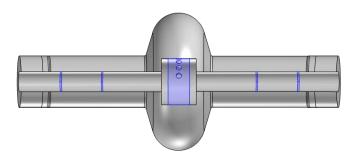
Mass flow rate: 30 L/min

Temperature: 15 °C

0.5 rotations per minute

Overall applied tension: 7.4 V

1.3GHz cavity with optimized EP parameters



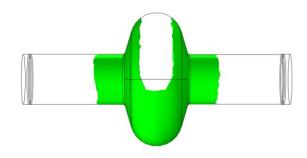
Mass flow rate: 10 L/min

Temperature: 15 °C

0.5 rotations per minute

Overall applied tension: 10.6 V

Original 1.3GHz cavity



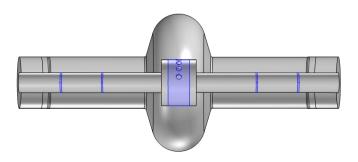
Mass flow rate: 30 L/min

Temperature: 15 °C

0.5 rotations per minute

Overall applied tension: 7.4 V

1.3GHz cavity with optimized EP parameters



Mass flow rate: 10 L/min

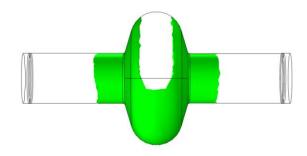
Temperature: 15 °C

0.5 rotations per minute

Overall applied tension: 10.6 V

Electropolished area

Original 1.3GHz cavity



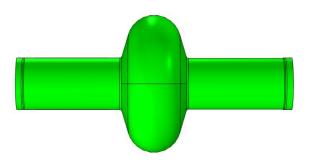
Mass flow rate: 30 L/min

Temperature: 15 °C

0.5 rotations per minute

Overall applied tension: 7.4 V

1.3GHz cavity with optimized EP parameters



Mass flow rate: 10 L/min

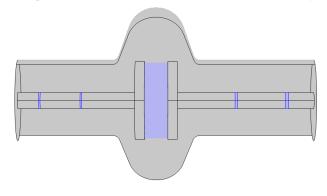
Temperature: 15 °C

0.5 rotations per minute

Overall applied tension: 10.6 V

Electropolished area

Original cathode 400MHz cavity



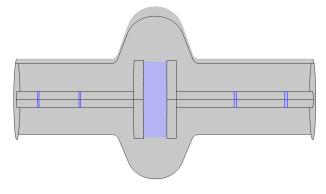
Mass flow rate	30L/min
Overall applied tension	29.5V
Power input	3.6 kW
Tinlet - Toutlet	2.8 K

Cathode optimisation 400MHz cavity

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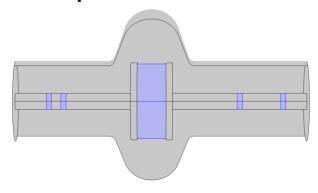
Electropolishing modelling and optimisation

Original cathode 400MHz cavity



Mass flow rate	30L/min
Overall applied tension	29.5V
Power input	3.6 kW
Tinlet - Toutlet	2.8 K

Cathode optimisation 400MHz cavity



Mass flow rate	30L/min
Overall applied tension	20.5V
Power input	2.2 kW
Tinlet - Toutlet	1.7 K



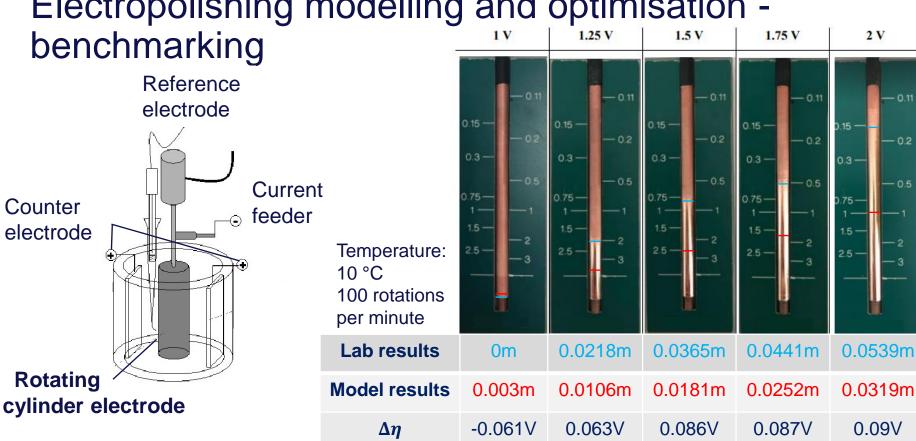


Cathode optimisation 400MHz cavity



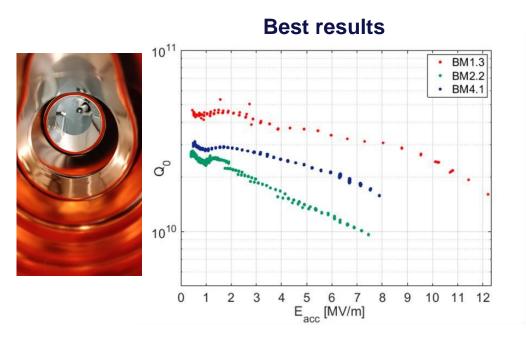
Mass flow rate	30L/min
Overall applied tension	29.5V
Power input	3.6 kW
Tinlet - Toutlet	2.8 K

Mass flow rate	30L/min
Overall applied tension	20.5V
Power input	2.2 kW
Tinlet - Toutlet	1.7 K



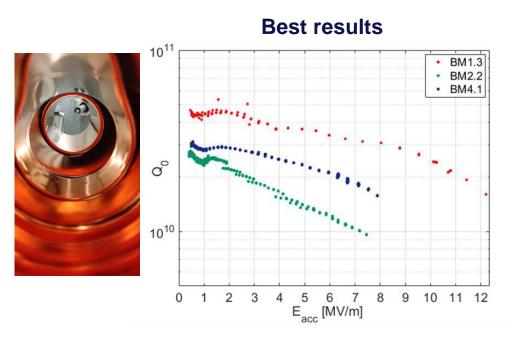
Experimental achievements

Electropolishing runs with 1.3 GHz copper cavity



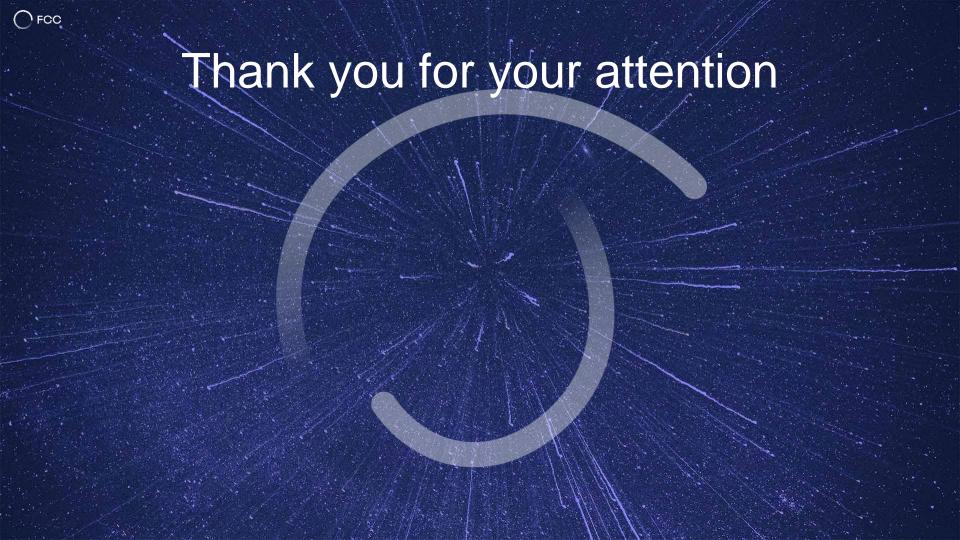
Experimental achievements

Electropolishing runs with 1.3 GHz copper cavity



On-going activities:

- Benchmark impact of temperature and fluid dynamics
- Process optimisation (lower power input, uniform EP)



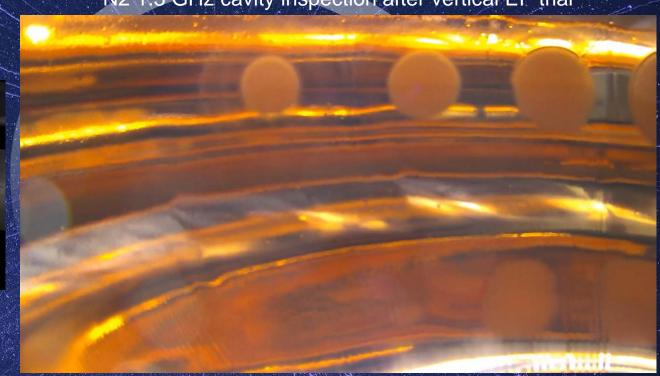


Thank you for your attention

N2 1.3 GHz cavity inspection after vertical EP trial



Cathode geometry



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Electropolishing modelling and optimisation

65.9 65.8

65.7 65.6

65.5

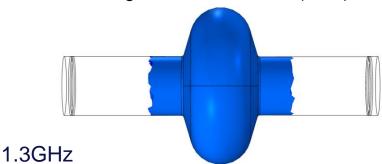
65.4 65.3

65.2

65.1

Application of: $i = f(\eta)$

Limiting current distribution (A/m²)



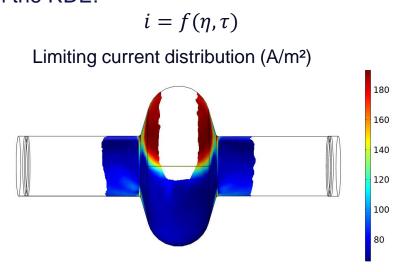
Mass flow rate: 30 L/min

Temperature: 15 °C

0.5 rotations per minute

Overall applied tension: 7.4 V

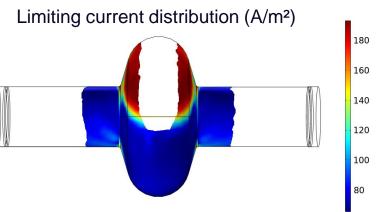
Creation of a new anodic current density function, originated from the results obtained with the RDE:



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Electropolishing modelling and optimisation

Original 1.3GHz cavity



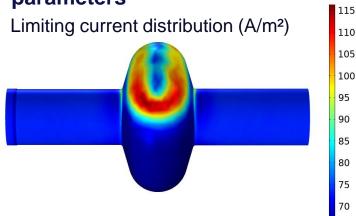
Mass flow rate: 30 L/min

Temperature: 15 °C

0.5 rotations per minute

Overall applied tension: 7.4 V





Mass flow rate: 10 L/min

Temperature: 15 °C

0.5 rotations per minute

Overall applied tension: 10.6 V